

## N-Channel Enhancement Mode MOSFET

### 1. Product Information

#### Features

- Shield Gate Trench technology
- Extremely low combination of  $R_{DS(ON)}$  and  $Q_g$
- Good stability and uniformity with high  $E_{AS}$

#### Applications

- PWM applications
- Load switch

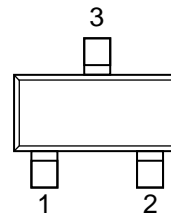
#### Quick reference

- $V_{DS} = 100V$
- $I_D = 3.0A$
- $R_{DS(ON)} \leq 125m\Omega @ V_{GS}=10V$  (Type: 100m $\Omega$ )
- $R_{DS(ON)} \leq 170m\Omega @ V_{GS}=4.5V$  (Type: 130m $\Omega$ )

#### Pin Description

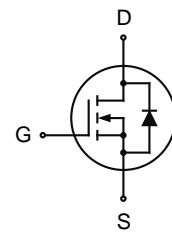
Pin	Description
1	Gate(G)
2	Source(S)
3	Drain(D)

#### Simplified Outline



Top View  
SOT-23

#### Symbol



### Package Marking and Ordering Information

Product Name	Package	Marking	Reel Size	Tape width	Quantity
KJ3N10S	SOT-23	3N10	-	-	3000

### 2. Absolute Maximum Ratings ( $T_A=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-source voltage	$V_{DS}$	100	V
Gate-source voltage	$V_{GS}$	$\pm 20$	V
Continuous drain current ( $T_J = 150^\circ C$ ) <sup>a</sup>	$T_A = 25^\circ C$	3.0	A
	$T_A = 70^\circ C$	2.4	
Pulsed drain current <sup>b</sup>	$I_{DM}$	12	
Power dissipation <sup>a</sup>	$T_A = 25^\circ C$	0.72	W
	$T_A = 70^\circ C$	0.46	
Operating junction and storage temperature range	$T_J, T_{stg}$	-55~150	$^\circ C$

## 3. Thermal Characteristics

Parameter		Symbol	Typ	Max	Unit
Maximum Junction-to-Ambient <sup>a</sup>	t ≤ 10s	R <sub>θJA</sub>	120	145	°C/W
	Steady-State		140	175	
Maximum Junction-to-Foot	Steady-State	R <sub>θJC</sub>	62	78	

### Notes

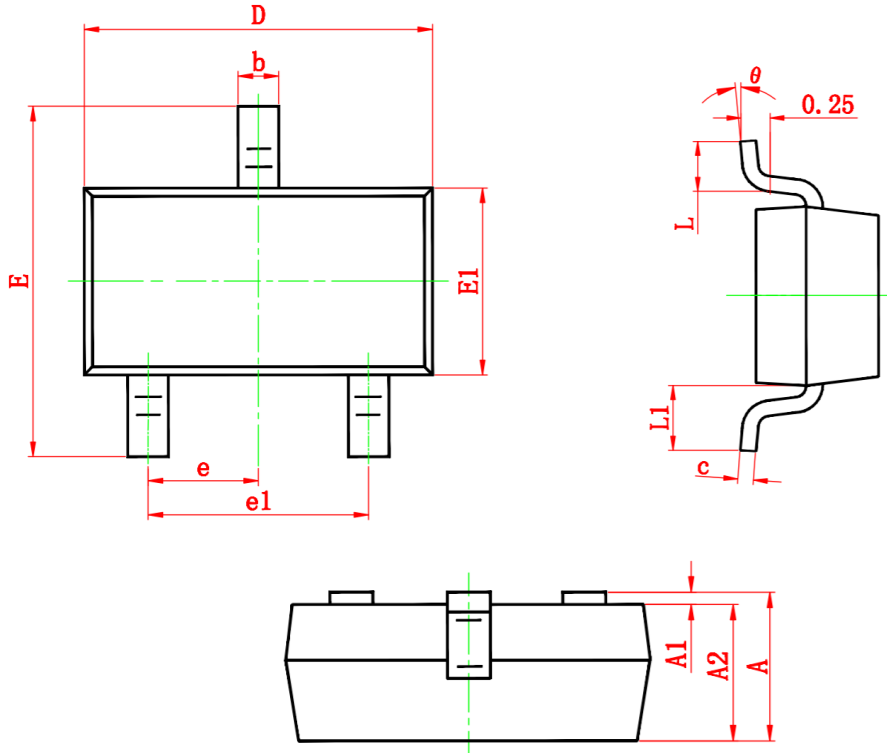
- Surface mounted on 1" x 1" FR4 board
- Pulse width limited by maximum junction temperature

## 4. Electrical Characteristics (T<sub>A</sub>=25°C, unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>OFF Characteristics</b>						
Drain-source breakdown voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	100	-	-	V
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> =100V, V <sub>GS</sub> =0V	-	-	1	μA
Gate-body leakage	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V	-	-	±100	nA
<b>ON Characteristics</b>						
Gate threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1.2	1.7	2.5	V
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =3A	-	100	125	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =2A	-	130	170	
Forward transconductance	g <sub>fs</sub>	V <sub>DS</sub> =10V, I <sub>D</sub> =2.4A	-	10	-	S
<b>Dynamic Characteristics</b>						
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> =0V V <sub>DS</sub> =50V F=1.0MHz	-	175	-	pF
Output capacitance	C <sub>oss</sub>		-	25	-	
Reverse transfer capacitance	C <sub>rss</sub>		-	1	-	
Gate Resistance	R <sub>G</sub>		4	7.5	12	Ω
<b>Switching Characteristics</b>						
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> =50V I <sub>D</sub> =1.5A V <sub>GS</sub> =10V R <sub>GEN</sub> =6Ω	-	1.1	-	nS
Turn-on Rise Time	t <sub>r</sub>		-	5.6	-	
Turn-off Delay Time	t <sub>d(off)</sub>		-	11	-	
Turn-off Fall Time	t <sub>f</sub>		-	10	-	
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =50V I <sub>D</sub> =1.5A V <sub>GS</sub> =10V	-	6.5	-	nC
Gate-Source Charge	Q <sub>gs</sub>		-	1.2	-	
Gate-Drain Charge	Q <sub>gd</sub>		-	0.98	-	
<b>Drain-source Diode Characteristics</b>						
Maximum Continuous Drain-Source Diode Forward Current	I <sub>S</sub>		-	-	1.1	A
Diode forward voltage	V <sub>SD</sub>	I <sub>SD</sub> =1.1A, V <sub>GS</sub> =0V	-	0.76	1.2	V

## 5. Package Mechanical Data

### SOT-23 Package



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	2.250	2.550	0.089	0.100
E1	1.200	1.400	0.047	0.055
e	0.950 TYP.		0.037 TYP.	
e1	1.800	2.000	0.071	0.079
L	0.300	0.500	0.012	0.020
L1	0.550 REF.		0.022 REF.	
$\theta$	0°	8°	0°	8°